



# Product Change Notification

**Change Notification #:** 118661-00  
**Change Title:** Select Boxed Intel® Core™ i9-11900K Processor,  
PCN 118661-00, Transport Media, Product Material  
Retail Box Packaging, and Disti Box Change for Boxed SKUs  
**Date of Publication:** November 09, 2021

## Key Characteristics of the Change:

Transport Media

## Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	December 09, 2021
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## Description of Change to the Customer:

Intel Corporation is changing the Retail Packaging Kit for select Rocket Lake i9-11900K CPU Boxed SKUs. This change decreases the volumetric storage requirements of the product by increasing the current consumer units per pallets from 560\* to 1620\*.

\*Actual pallet quantities vary by site

- Existing custom packaging kit will be replaced with an Intel standard folding carton
- Existing Disti Box will be replaced with desktop K SKU Disti Box
- Existing labels and format will be replaced with Intel standard folding carton label placement and format

## Universal Box Packaging MM#99AFV2

Current Package



New Package



## China Box Packaging MM#99AFW1

Current Package



New Package



## Customer Impact of Change and Recommended Action:

This packaging change will affect the appearance of the shipping container for distributors and the internal packaging components. This change may result in decrease costs for shipping box configuration. This change results in material procurement simplicity and standardized palletization usage whereby decreasing volumetric storage requirements. There is no change to the form, fit or function of the label or product contained therein, therefore no action is needed by customers. Customers may see a mix of products until inventory has been depleted. Customers may also receive post-conversion material before the above target date if the current inventory is depleted sooner.

## Products Affected/Intel Ordering Codes:

Marketing Name	Stepping	MM#	Product Code	Spec Code	Platform
Boxed Intel® Core™ i9-11900K Processor	B0	99AFV2	BX8070811900K	S RKND	DESKTOP
Boxed Intel® Core™ i9-11900K Processor	B0	99AFW1	BXC8070811900K	S RKND	DESKTOP

## PCN Revision History:

**Date of Revision:**

November 09, 2021

**Revision Number:**

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**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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